4-bit 1-of-2 FET Multiplexer / Demultiplexer

HITACHI

ADE-205-624B (Z)

Rev. 2 Nov. 2001

Description

The HD74CBT3257 is a 4-bit 1-of-2 high-speed TTL-compatible FET multiplexer / demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

Output enable (\overline{OE}) and select control (S) inputs select the appropriate B1 and B2 outputs for the A-input data.

Features

- Minimal propagation delay through the switch.
- 5 Ω switch connection between two ports.
- TTL-compatible input levels.
- Ultra low quiescent power.
 - -Ideally suited for notebook applications.
- Package type

Product code example: HD74CBT3257TELL

Package type	Package code	Package suffix	Taping code
TSSOP-16pin	TTP-16DA	Т	ELL(2000pcs / Reel)

Notes: 1. As for the Pb-free package is attached the "V" to the end of package code.

2. As for the Pb-free product is attached the "-E" to the end of product code.



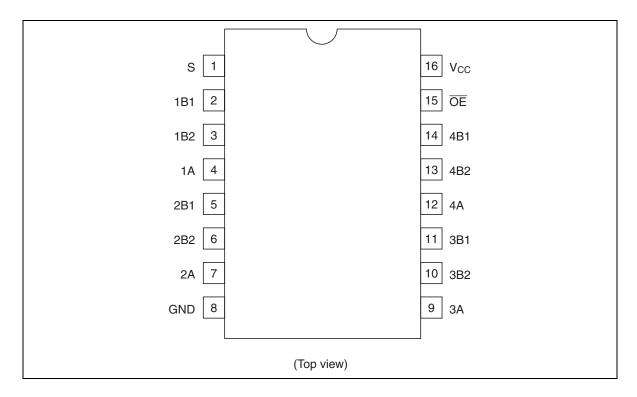
Function Table

Inputs

ŌĒ	s	Function
L	L	A port = B1 port
L	н	A port = B2 port
Н	X	Disconnect

H: High level
L: Low level
X: Immaterial

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{cc}	-0.5 to 7.0	V	_
Input voltage range *1	V _i	-0.5 to 7.0	V	
Input clamp current	I _{IK}	-50	mA	V ₁ < 0
Continuous output current	I _o	128	mA	$V_{o} = 0$ to V_{cc}
Continuous current through V_{cc} or GND	I _{CC} or I _{GND}	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) ^{'2}	P _T	500	mW	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

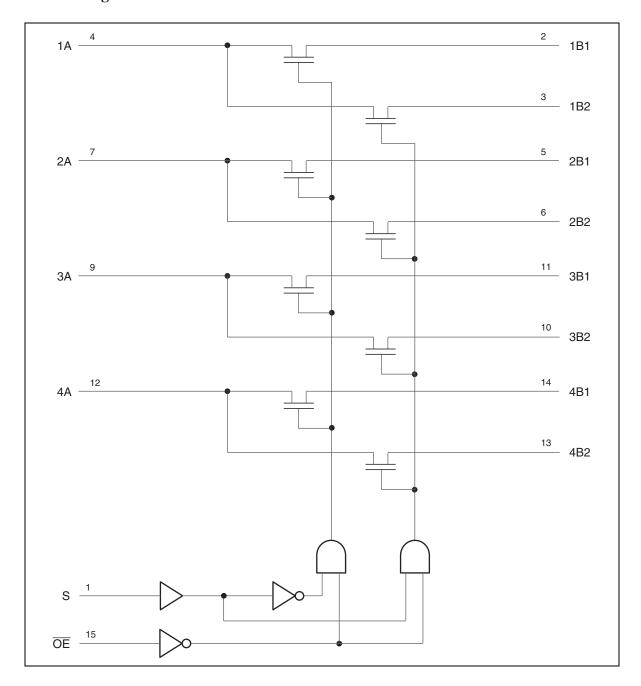
- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{cc}	4.0	5.5	V	
Input voltage range	V _I	0	5.5	V	
Output voltage range	V _{I/O}	0	5.5	V	
Input transition rise or fall rate	Δt / Δν	0	5	ns / V	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Block Diagram



DC Electrical Characteristics

 $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	V_{cc} (V)	Min	Typ *1	Max	Unit	Test conditions
Clamp diode voltage	V _{IK}	4.5	_	_	-1.2	V	$I_{IN} = -18 \text{ mA}$
Input voltage	V _{IH}	4.0 to 5.5	2.0	_	_	V	
	V _{IL}	4.0 to 5.5	_	_	0.8		
On-state switch resistance ²	R _{on}	4.0	_	14	20	Ω	$V_{IN} = 2.4 \text{ V},$ $I_{IN} = 15 \text{ mA}$ Typ at $V_{CC} = 4.0 \text{ V}$
		4.5	_	5	7		$ \overline{V_{IN} = 0 V,} $ $ I_{IN} = 64 \text{ mA} $
		4.5	_	5	7		$V_{IN} = 0 \text{ V},$ $I_{IN} = 30 \text{ mA}$
		4.5	_	10	15		$V_{IN} = 2.4 \text{ V},$ $I_{IN} = 15 \text{ mA}$
Input current	I _{IN}	0 to 5.5	_	_	±1.0	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Off-state leakage current	l _{oz}	5.5	_	_	±1.0	μА	0 ≤ A, B ≤ V _{cc}
Quiescent supply current	I _{cc}	5.5	_	_	3	μА	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$ mA
Increase in I _{cc} per input ^{'3}	ΔI_{cc}	5.5	—	_	2.5	mA	One input at 3.4 V, other inputs at V _{cc} or GND

Notes: For condition shown as Min or Max use the appropriate values under recommended operating conditions.

- 1. All typical values are at $V_{\rm cc}$ = 5 V (unless otherwise noted), Ta = 25°C.
- 2. Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower voltage of the two (A or B) terminals.
- 3. This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{\rm cc}$ or GND.

Capacitance

 $(Ta = 25^{\circ}C)$

Item		Symbol	$V_{cc}(V)$	Min	Тур	Max	Unit	Test conditions
Control input capacitance		C _{IN}	5.0	_	3.5	_	pF	$V_{IN} = 0 \text{ or } 3 \text{ V}$
Input / output	A port	$C_{I/O(OFF)}$	5.0	_	9	_	pF	$V_o = 0 \text{ or } 3 \text{ V}$
capacitance	B port	_	5.0	_	5	_		$\overline{OE} = V_{CC}$

Note: This parameter is determined by device characterization is not production tested.

Switching Characteristics

 $(Ta = -40 \text{ to } 85^{\circ}C)$

•
$$V_{cc} = 4.0 \text{ V}$$

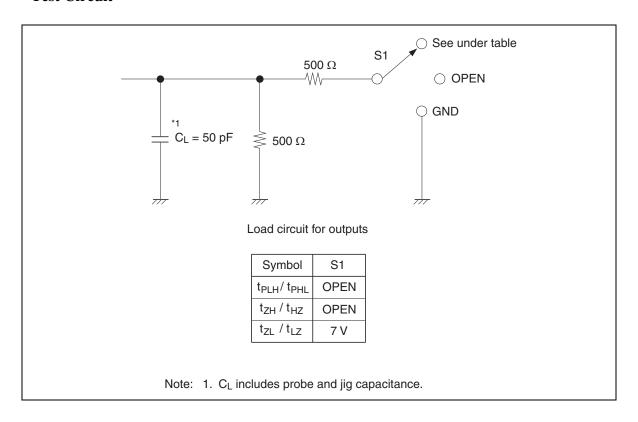
Item	Symbol	Min	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time 1	t _{PLH} t _{PHL}	_	0.35	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	A or B	B or A
Propagation delay time	t _{plH} t _{pHL}	_	5.5	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	S	А
Enable time	t _{zн}	_	5.7	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	S	В
	$\mathbf{t}_{_{\mathrm{ZL}}}$	_	5.6			ŌĒ	A or B
Disable time	t _{HZ}	_	5.2	ns	C _L = 50 pF	S	В
		_	5.5		$R_{L} = 500 \Omega$	ŌĒ	A or B
	t _{LZ}	_	5.2			S	В
		_	6.4			ŌĒ	A or B

• $V_{CC} = 5.0 \pm 0.5 \text{ V}$

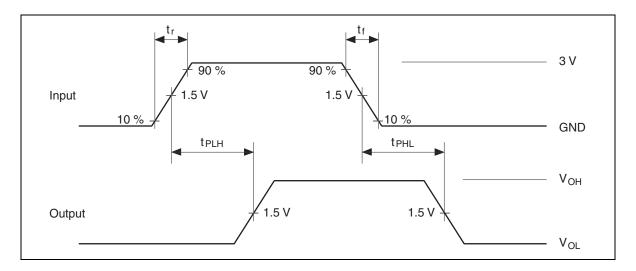
Item	Symbol	Min	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time *1	t _{PLH} t _{PHL}	_	0.25	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	A or B	B or A
Propagation delay time	t _{PLH} t _{PHL}	1.6	5.0	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	S	A
Enable time	t _{zн}	1.6	5.2	ns	C _L = 50 pF	S	В
	$t_{_{ZL}}$	1.8	5.1		$R_{L} = 500 \Omega$	ŌĒ	A or B
Disable time	t _{HZ}	1.0	5.0	ns	C _L = 50 pF	S	В
		2.2	5.5		$R_L = 500 \Omega$	ŌĒ	A or B
	t _{LZ}	1.0	5.0			S	В
		2.2	6.8			ŌĒ	A or B

Note: 1. The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

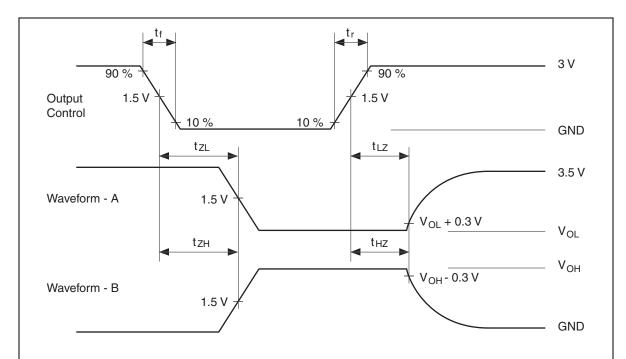
Test Circuit



Waveforms - 1

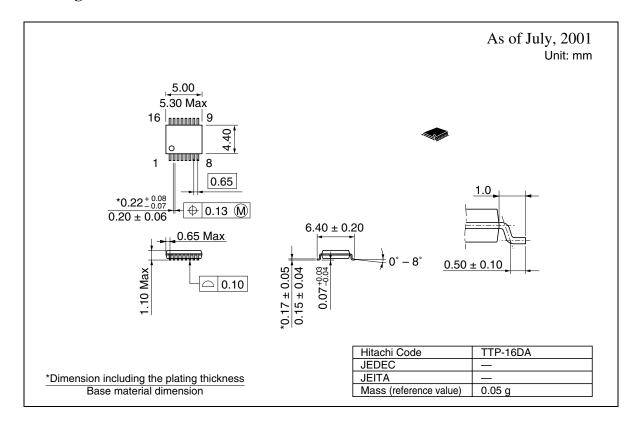


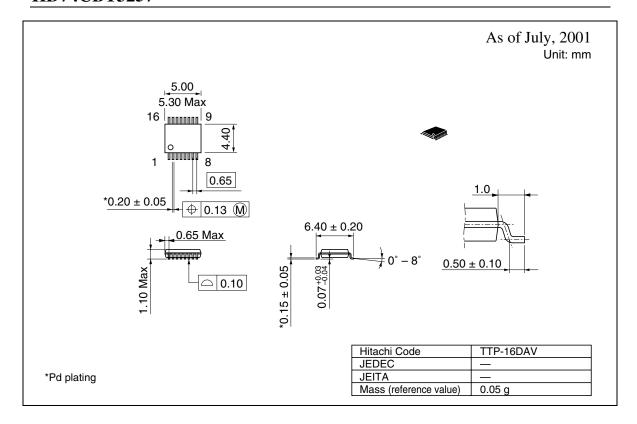
Waveforms - 2



- Notes: 1. All input pulses are supplied by generators having the following characteristics : PRR \leq 10 MHz, Z_{O} = 50 $\Omega,\,t_{f}\leq$ 2.5 ns, $t_{f}\leq$ 2.5 ns.
 - 2. Waveform A is for an output with internal conditions such that the output is low except when disabled by the output control.
 - 3. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.
 - 4. The output are measured one at a time with one transition per measurement.

Package Dimensions





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